Form PTO 1449				Attorney Docket No. 8733.307.00		ication No. 39,483			
U.S. DEPARTMENT OF COMMÉRCE PATENT AND TRADEMARK OFFICE				09 709 483				485	
LIST OF REFERENCES CITED BY APPLICANT				Applicant Oh-Nam KWON					
(Use Several Sheets if Necessary) Date: May 14, 2001				Filing Date Group November 13, 2000 Unassign		Group Unassigned	2823		
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Top		Cecilia Y. Mak; MRS Bulletin; "Electroless Copper Deposition on Metals and Metal Silicides"; August 1994; (Pages 55-61)							
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*EXAMINER: Initial if reference is considered, whether or not citation is in conformance with MPEP 609; Draw line through citation									
if not in conformance and not considered. Include copy of this form with next communication to applicant. **English-language abstract provided.									